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() IDT.

LOW PHASE NOISE CLOCK MULTIPLIER

ICS601-21

DATASHEET

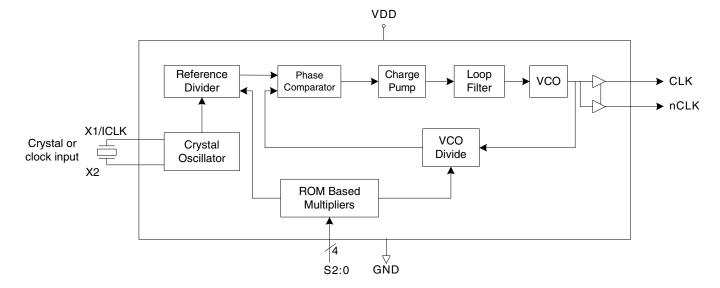
Description

The ICS601-21 is a low-cost, low phase noise, high performance clock synthesizer for applications which require low phase noise and low jitter. It is IDT's lowest phase noise multiplier. Using IDT's patented analog and digital Phase Locked Loop (PLL) techniques, the chip accepts a crystal or clock input, and produces output clocks up to 230 MHz at 3.3 V.

This product is intended for clock generation. It has low output jitter (variation in the output period), but input to output skew and jitter are not defined nor guaranteed.

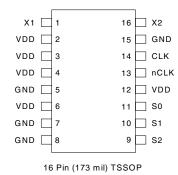
Features

- Fully integrated PLL, no external loop filter required
- Differential 3.3 V LVPECL outputs
- Uses fundamental crystal or clock
 - Crystal input frequency: 10 to 27MHz
 - Clock input: 10 to 38MHz (mulitply by 6)
 10 to 31MHz (all other multiply settings)
- Output clocks up to 230 MHz at 3.3 V
- Low phase noise: -122 dBc/Hz at 10 kHz
- Low jitter 15 ps one sigma typ.
- Powerdown mode lowers power consumption
- Packaged in 16-pin TSSOP, Pb-free
- Advanced, low power, sub-micron CMOS process
- Operating voltage of 3.3 V
- Commercial temperature range available



Block Diagram

Pin Assignment



Multiplier Select Table

S2	S1	S0	Multiplier
0	0	0	x1
0	0	1	x2
0	1	0	x3
0	1	1	x4
1	0	0	x5
1	0	1	x6
1	1	0	x8
1	1	1	x16

0 = connect directly to ground

1 = connect directly to VDD

Pin Descriptions

Pin Number	Pin Name	Pin Type	Pin Description
1	X1	XI	Crystal or clock input. Connect to a fundamental parallel mode crystal or clock input. See electrical tables for input frequenct ranges.
2 - 4	VDD	Power	Connect to +3.3 V.
5	GND	Power	Connect to ground.
6	VDD	Power	Connect to +3.3 V.
7 - 8	GND	Power	Connect to ground.
9	S2	Input	Select pin 2. Internal pull-up resistor.
10	S1	Input	Select pin 1. Internal pull-up resistor.
11	S0	Input	Select pin 0. Internal pull-up resistor.
12	VDD	Power	Connect to +3.3 V.
13	nCLK	Output	Inverted differential clock output.
14	CLK	Output	Differential clock output.
15	GND	Power	Connect to ground.
16	X2	ХО	Crystal connection. Connect to a fundamental parallel mode crystal or leave unconnected for clock input. See electrical tables for input frequenct ranges.

External Components

The ICS601-21 requires a minimum number of external components for proper operation. Decoupling capacitors of 0.01 μ F and 0.1 μ F should be connected between VDD and GND, as close to the part as possible. A 50 Ω terminating resistor should be used on each clock output. (See termination diagram on page 5). The crystal must be connected as close to the chip as possible. The crystal should be fundamental mode, parallel resonant. Do not use third overtone. For exact tuning when using a crystal, capacitors should be connected from pins X1 to ground and X2 to ground. In general, the value of these capacitors is given by the following equation, where CL is the crystal load capacitance: Crystal caps (pF) = (CL-5) x 2. So for a crystal with 16 pF load capacitance, two 22 pF caps can be used. For any given board layout, IDT can measure the board capacitance and recommend the exact capacitance value to use.

Absolute Maximum Ratings

Stresses above the ratings listed below can cause permanent damage to the ICS601-21. These ratings, which are standard values for IDT commercially rated parts, are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods can affect product reliability. Electrical parameters are guaranteed only over the recommended operating temperature range.

Item	Rating
Supply Voltage, VDD	7 V
All Inputs and Outputs	-0.5 V to VDD+0.5 V
Ambient Operating Temperature, Commercial version	0 to +70 °C
Storage Temperature	-65 to +150 °C
Junction Temperature	125 °C
Soldering Temperature	260 °C

Recommended Operation Conditions

Parameter	Min.	Тур.	Max.	Units
Ambient Operating Temperature	0		+70	°C
Power Supply Voltage (measured in respect to GND)	+3.0		+3.6	V

DC Electrical Characteristics

VDD=3.3 V ±0.3V,	Ambient tem	perature 0 to +70°C
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Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Operating Voltage	VDD		3.0		3.6	V
Input High Voltage	V _{IH}	X1/ICLK pin only	VDD/2+1			V
Input Low Voltage	V _{IL}	X1/ICLK pin only			VDD/2-1	V

DC Electrical Characteristics (continued)

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Input High Voltage	V _{IH}	Input select pins	2		VDD	V
Input Low Voltage	V _{IL}	Input select pins			0.8	V
Output High Voltage	V _{OH}	Note 1	VDD-1.4		VDD-1.0	V
Output Low Voltage	V _{OL}	Note 1	VDD-2.0		VDD-1.7	V
Output Voltage Swing	V _{swing}	Peak to Peak	0.6		0.95	V
Operating Supply Current	IDD	Note 1, 125 MHz		30	45	mA
Input Capacitance	C _{IN}	Input select pins		5		pF
On Chip Pull-up Resistor	R _{PU}	Input select pins		510		kΩ

Note 1: Outputs terminated with 50 $\!\Omega$ to VDD-2V

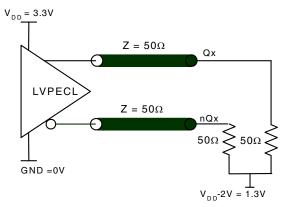
AC Electrical Characteristics

$VDD = 3.3 V \pm 0.3V$,	Ambient Temperature 0 to +70° C
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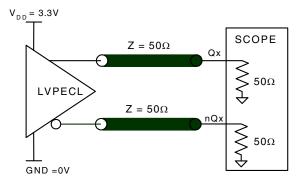
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Crystal Input Frequency	Fin	Note 2	10		27	MHz
Clock Input Frequency	Fin	Note 2, "Multiply by 6" setting	10		38	MHz
		Note 2, excluding "Multiply by 6" setting	10		31	MHz
Output Frequency			10		230	MHz
Output Rise Time	t _{OR}	20% to 80%, no load		600	900	ps
Output Fall Time	t _{OF}	80% to 20%, no load		900	1200	ps
Output Clock Duty Cycle		at VDD/2	45	50	55	%
Maximum Absolute Jitter, short term, 125 MHz		No load		±50	±75	ps
Maximum Jitter, one sigma, 125 MHz (x5)		No load		12	20	ps
Phase Noise, relative to carrier, 125 MHz (x5)		100 Hz offset	-90	-94		dBc/Hz
Phase Noise, relative to carrier, 125 MHz (x5)		1 kHz	-116	-120		dBc/Hz
Phase Noise, relative to carrier, 125 MHz (x5)		10 kHz offset	-118	-122		dBc/Hz
Phase Noise, relative to carrier, 125 MHz (x5)		100 kHz offset	-115	-119		dBc/Hz

Note 2: Input frequency limited by maximum output frequency and multiplication factor (I.e. For 16x, maximum input frequency is 13.75 MHz).

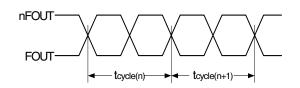
Parameter Measurement Information



3.3V LVPECL Driver Termination

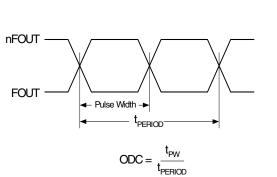


3.3V Output Load AC Test Circuit

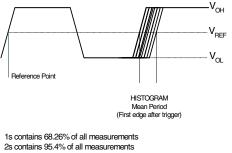


tjit(cc) = tcycle(n) - tcycle(n+1) 1000 Cycles

CYCLE-TO-CYCLE JITTER

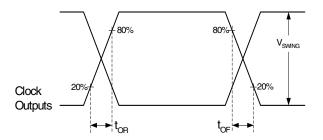


OUTPUT DUTY CYCLE AND tPERIOD



25 contains 95.4% of all measurements 3s contains 99.73% of all measurements 4s contains 99.99366% of all measurements 6s contains (100-1.973x10⁷)% of all measurements

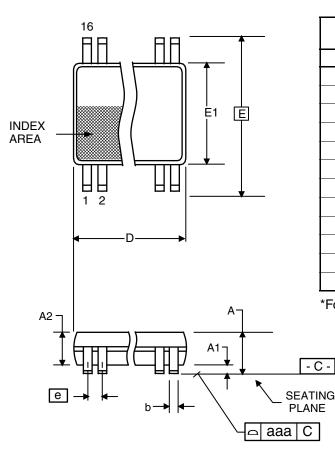
Period Jitter



OUTPUT RISE/FALL TIME

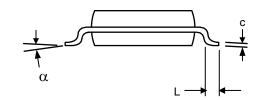
Package Outline and Package Dimensions (16-pin TSSOP, 173 Mil. Narrow Body)

Package dimensions are kept current with JEDEC Publication No. 95



	Millim	neters	Incl	nes*	
Symbol	Min	Max	Min	Max	
A		1.20		0.047	
A1	0.05	0.15	0.002	0.006	
A2	0.80	1.05	0.032	0.041	
b	0.19	0.30	0.007	0.012	
С	0.09	0.20	0.0035	0.008	
D	4.90	5.1	0.193	0.201	
E	6.40 E	BASIC	0.252 BASIC		
E1	4.30	4.50	0.169	0.177	
е	0.65	Basic	0.0256	8 Basic	
L	0.45	0.75	0.018	0.030	
α	0°	8°	0°	8 °	
aaa		0.10		0.004	

*For reference only. Controlling dimensions in mm.



Ordering Information

Part / Order Number	Marking	Shipping Packaging	Package	Temperature
601G-21LF	601G-21LF	Tubes	16-pin TSSOP	0 to +70° C
601G-21LFT	601G-21LF	Tape and Reel	16-pin TSSOP	0 to +70° C

"LF" suffix to the part number denotes Pb-Free configuration, RoHS compliant.

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Revision History

Rev.	Date	Originator	Description of Change
J	12/14/12	A. Tsui	 Updated Clock Input and Output frequencies in AC Char table and on front page of DS per characterization report. Removed leaded parts from Orderables table.

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